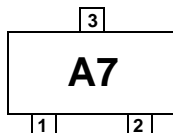
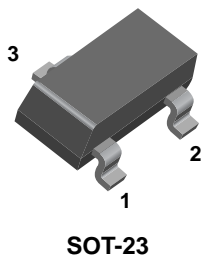
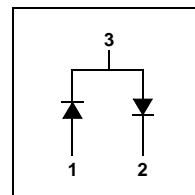


# BAV99

## Small Signal Diode



Connection Diagram



### Absolute Maximum Ratings\* $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Maximum Repetitive Reverse Voltage	70	V
$I_{F(AV)}$	Average Rectified Forward Current	200	mA
$I_{FSM}$	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 300 microseconds	1.0	A
		8.0	A
$T_{stg}$	Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_j$	Operating Junction Temperature	-55 to +150	$^\circ\text{C}$

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### NOTES:

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

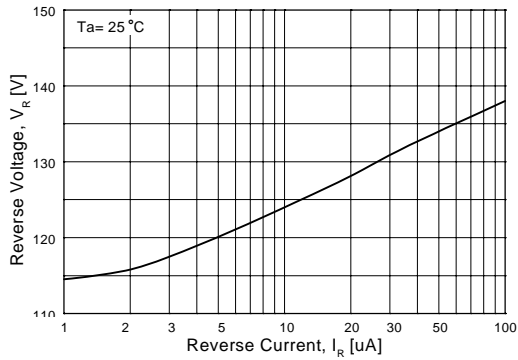
### Thermal Characteristics

Symbol	Parameter	Value	Units
$P_D$	Power Dissipation	350	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	$^\circ\text{C/W}$

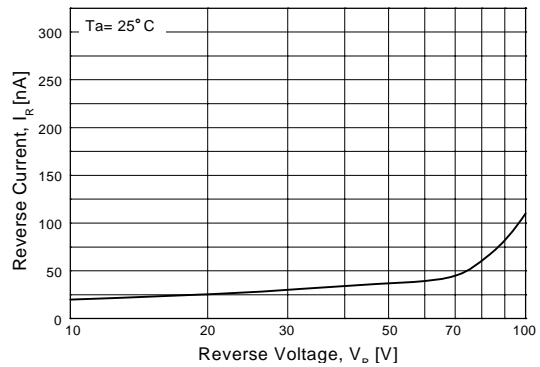
### Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
$V_R$	Breakdown Voltage	$I_R = 100\mu\text{A}$	70		V
$V_F$	Forward Voltage	$I_F = 1.0\text{mA}$		715	mV
		$I_F = 10\text{mA}$		855	mV
		$I_F = 50\text{mA}$		1.0	V
		$I_F = 150\text{mA}$		1.25	V
$I_R$	Reverse Leakage	$V_R = 70\text{V}$		2.5	$\mu\text{A}$
		$V_R = 25\text{V}, T_A = 150^\circ\text{C}$		30	$\mu\text{A}$
		$V_R = 70\text{V}, T_A = 150^\circ\text{C}$		50	$\mu\text{A}$
$C_T$	Total Capacitance	$V_R = 0\text{V}, f = 1.0\text{MHz}$		1.5	pF
$t_{rr}$	Reverse Recovery Time	$I_F = I_R = 10\text{mA}, I_{RR} = 1.0\text{mA}, R_L = 100\Omega$		6.0	ns

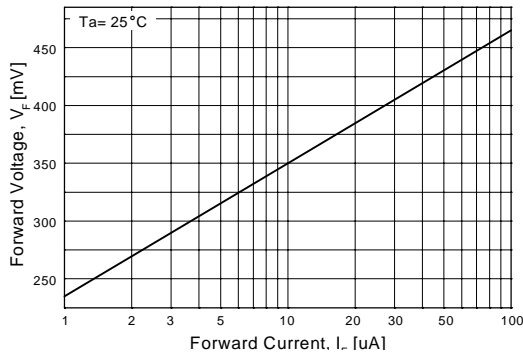
## Typical Performance Characteristics



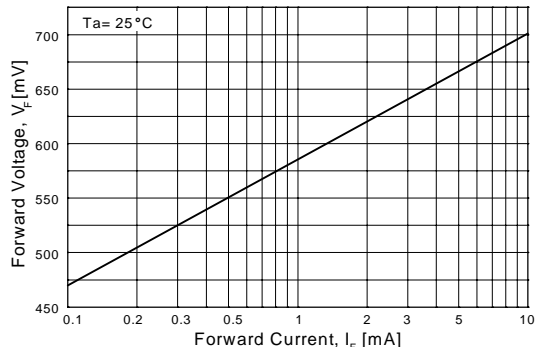
**Figure 1. Reverse Voltage vs Reverse Current**  
BV - 1.0 to 100uA



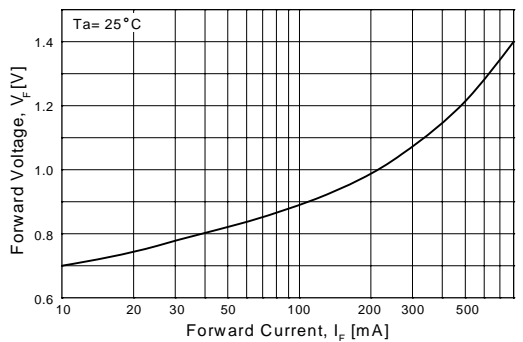
**Figure 2. Reverse Current vs Reverse Voltage**  
IR - 10 to 100 V



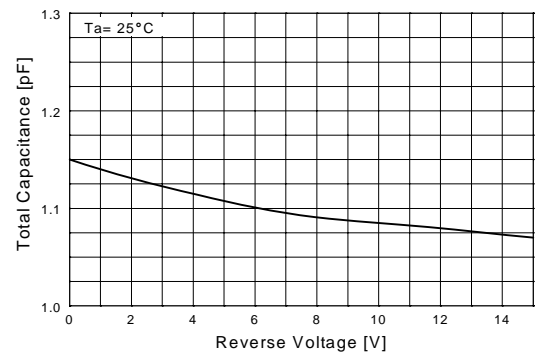
**Figure 3. Forward Voltage vs Forward Current**  
VF - 1.0 to 100 uA



**Figure 4. Forward Voltage vs Forward Current**  
VF - 0.1 to 10 mA

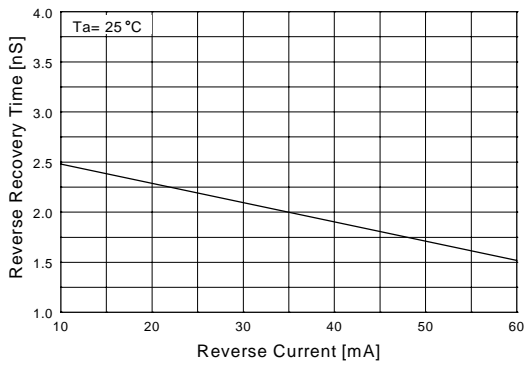


**Figure 5. Forward Voltage vs Forward Current**  
VF - 10 - 800 mA

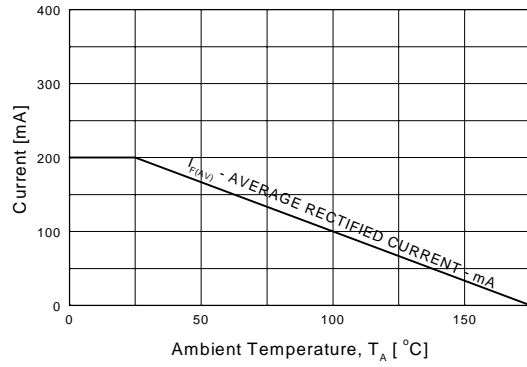


**Figure 6. Total Capacitance vs Reverse Voltage**

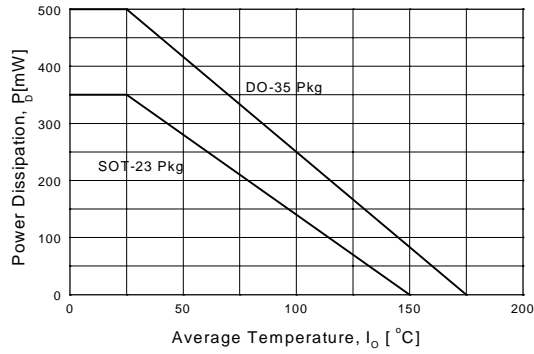
**Typical Performance Characteristics (Continued)**



**Figure 7. Reverse Recovery Time vs Reverse Current**  
TRR - IR 10 mA vs 60 mA



**Figure 8. Average Rectified Current ( $I_{F(AV)}$ ) versus Ambient Temperature ( $T_A$ )**







**Figure 9. Power Derating Curve**



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